Trusted Foundry Program

As of 28 November 2016

Accredited Suppliers

Important: Many of the following suppliers have a standard commercial (untrusted) product flow in addition to a trusted product flow. The "Trusted Product Flow" must be explicitly requested from the points of contact below to ensure the resulting product and/or service is trusted. A trusted supply chain begins with trusted design and continues with trusted mask, foundry, packaging/assembly, and test services.

Supplier	CAGE Code	Facility Location	Scope of Accreditation	POC	Email Address	Telephone Number
Advotech Company, Inc.	4GBU7	Tempe, AZ	Packaging/Assembly	Trusted IC Director	trusted.director@advotech.com	(480) 736-0406
Aeroflex Colorado Springs	65342	Colorado Springs, CO	Broker; Design; Aggregation; Packaging/Assembly; Test	Michael Newman	mike.newman@aeroflex.com	719-594-8007
Aeroflex Plainview, Inc.	88379	Plainview, NY	Packaging/Assembly	Arthur Mahase	Arthur.Mahase@cobham.com	(516) 752-2448
Arkham Technology, Ltd.	47RG0	Irvine, CA	Design	Otaway Thomas, CISSP, ISSEP	othomas@arkhamtechnology.com	(949) 228-6677
Atessa, Inc.	66UM6	Pleasanton, CA	Design	Marketing Manager	info@atessainc.com	(925) 469-0063
Atlantic Analytical Laboratory, LLC	0JV70	Whitehouse, NJ	Test	Bruce Gollob	bgollob@atlanticanalytical.com	(908)534-5600
Aurora Semiconductor, LLC	7EUL9	St. Petersburg, FL	Post Processing; Packaging/Assembly	Charles Azizi	Charles.Azizi@AuroraSemi.Com	727-235-6532
BAE Systems Electronic Systems	1RU44	Manassas, VA	Broker; Design; Aggregation; Packaging/Assembly; Test	Stewart Ocheltree	stewart.ocheltree@baesystems.com	(571)364-7624
BAE Systems Microelectronics Center Nashua	94117	Nashua, NH	Foundry Services	John Woodhouse	john.woodhouse4@baesystems.com	(603) 885-9570
Boeing Company, The	81205	Seattle, WA	Design	Business Development Manager	Michael.w.carson@boeing.com	(253) 657-8056
Boeing Network and Space Systems (N&SS)	9E831	El Segundo, CA	Design; Test	Eric Miller	Eric.J.Miller@boeing.com	(310) 416-5314
CORWIL Technology Corporation	061F4	Milpitas, CA	Post Processing; Packaging/Assembly	Dave Fiore	david.fiore@corwil.com	(408)618-8733
CREE, Inc.	0C9J8	Durham, NC	Foundry Services	Jeff Barner	jeff_barner@cree.com	(919)-287-7515
Criteria Labs, Inc.	1NQ10	Austin, TX	Broker; Packaging/Assembly; Test	Doug Myron	dmyron@criterialabs.com	(512) 637-4549
Cypress Semiconductor Minnesota, Inc.	5AZZ0	Bloomington, MN	Broker; Design; Foundry Services; Test	Brad Ferguson, PhD, Wafer Foundry Services Business Development Manager	trustedfoundry@cypress.com	(952) 851-5190
Defense Microelectronics Activity	088N9	McClellan, CA	Broker; Design; Foundry Services; Packaging/Assembly; Test	Jerry Tucker	tucker@dmea.osd.mil	(916) 231-1593
DPA Components International	6S055	Simi Valley, CA	Packaging/Assembly; Test	Doug Schweitzer	dougs@dpaci.com	(805) 581-9200
e2v, inc.	0C7V7	Milpitas, CA	Broker; Design; Packaging/Assembly; Test	Mont Taylor Dir. of Business Development	mont.taylor@e2v-us.com	(408) 585-7138

General Dynamics Mission Systems	3CYA2	Bloomington, MN	Broker; Design	Dana Curran	Dana.curran@gd-ms.com	(916)565-5304
General Dynamics Mission Systems, Scottsdale	1VPW8	Scottsdale, AZ	Broker; Design	Jim Garvey, Manager ASIC Design Center	James.Garvey@gd-ais.com	(480) 586-3355
GLOBALFOUNDRIES U.S. 2 LLC BTV	7DR37	Essex Junction, VT	Broker; Mask Manufacturing; Foundry Services; Post Processing	David Sobczak	david.sobczak@globalfoundries.com	(802) 769-2208
GLOBALFOUNDRIES U.S. 2 LLC EFK	7DR38	Hopewell Junction, NY	Foundry Services; Post Processing	David Sobczak	david.sobczak@globalfoundries.com	(802) 769-2208
Harris Corporation Government Communications Systems Division	91417	Melbourne, FL	Design; Packaging/Assembly; Test	Louis Paradiso, Group Leader	lparadis@harris.com	(321) 727-5399
Honeywell Aerospace Plymouth	34168	Plymouth, MN	Design; Foundry Services; Packaging/Assembly; Test	Barry Johnson, Western States Manager	Barry.W.Johnson@honeywell.com	(763) 954-2118
HRL Laboratories, LLC.	27457	Malibu, CA	Foundry Services	Kay Son, Ph.D.	kson@hrl.com	(310) 317-5977
i3 Electronics, Inc.	70S94	Endicott, NY	Packaging/Assembly	Michelle Eldred	Michelle.Eldred@i3electronics.com	(607) 755-8003
IBM Corporation Bromont	L04D9	Bromont, Quebec, Canada	Post Processing; Packaging/Assembly	Michael James	jamm@us.ibm.com	(802) 769-5069
IBM Corporation Burlington	15898	Essex Junction, VT	Broker; Design; Mask Data Parsing; Test	Michael James	jamm@us.ibm.com	(802) 769-5069
IBM Corporation East Fishkill	1D185	Hopewell Junction, NY	Broker	Michael James	jamm@us.ibm.com	(802) 769-5069
Integra Technologies, LLC	1SRY1	Wichita, KS	Broker; Test	Dan Miller	Dan.Miller@integra-tech.com	316-630-6825
Intrinsix Corp.	0N6C1	Marlborough, MA	Design	Jim Gobes, CEO	jgobes@intrinsix.com	(508) 658-7658
Jazz Semiconductor Trusted Foundry	6PN00	Newport Beach, CA	Broker	Scott Jordan	Jordans1@jazztrusted.com	(949) 861-3519
Johns Hopkins University, Applied Physics Laboratory	88898	Laurel, MD	Design	Dan Silvera, ASIC Program Manager	Daniel.Silvera@jhuapl.edu	240-228-2059
L-3 Communications Systems - West	06401	Salt Lake City, UT	Design	Rick Crist	rick.a.crist@L-3com.com	(801)594-3336
Lockheed Martin Missiles and Fire Control, Orlando Site	04939	Orlando, FL	Design	Howard Phang	howard.m.phang@lmco.com	(407) 356-6551
Lockheed Martin Space Systems Company, Denver Site	04236	Littleton, CO	Design	Deanna Doner	deanna.e.doner@lmco.com	(303) 971-5392
Lockheed Martin Space Systems Company, Sunnyvale Site	06887	Sunnyvale, CA	Design	Deanna Doner	deanna.e.doner@lmco.com	(303) 971-5392
Lockheed Martin Space Systems Company, Valley Forge Site	79272	King of Prussia, PA	Design	Deanna Doner	deanna.e.doner@lmco.com	(303) 971-5392
M/A-COM Technology Solutions Inc.	55NN2	Lowell,MA	Foundry Services; Post Processing	Kim Conway	kimberly.conway@macomtech.com	(978) 656-2561
MacAulay-Brown, Inc.	6V5Z8	Roanoke, VA	Design	Barry Polakowski	Barry.Polakowski@macb.com	(540) 283-7555
Maxtek Components Corporation dba Tektronix Component Solutions	06MJ2	Beaverton, OR	Design; Packaging/Assembly; Test	Sales Manager	Components@tektronix.com	(800) 462-9835

Mercury Corp. - Memory and Storage Solutions	54230	Phoenix, AZ	Broker; Packaging/Assembly; Test	Iain Mackie	Iain.Mackie@mrcy.com	(360) 921 8943
Mercury Systems - Sensor and Mission Processing	3X893	Chelmsford, MA	Design	Edward Conant	Edward.Conant@defense.mrcy.com	(657)465-0208
Microsemi SOC San Jose, CA	0J4Z0	San Jose, CA	Broker; Design; Test	Dina Smith	dina.smith@microsemi.com	(408) 643-6438
MIT Lincoln Laboratory Microelectronics Laboratory	3G050	Lexington, MA	Design; Foundry Services; Post Processing	Director of the Microelectronics Laboratory, Advanced Techology Division	MEL-Director@ll.mit.edu	(781) 981-7803
National Security Campus - Kansas City	14061	Kansas City, MO	Broker; Design; Aggregation; Post Processing; Packaging/Assembly; Test	Trusted Services Program Lead	tfa@nnsa.doe.gov	(816) 488-7697
NEO Tech	09059	Chatsworth, CA	Packaging/Assembly	Steve Heinzen V.P. Marketing	steve.heinzen@neotech.com	(510) 933-6065
Northrop Grumman Aerospace Systems	11982	Redondo Beach, CA	Design; Foundry Services; Packaging/Assembly	Myra de Leon	myra.deleon@ngc.com	(310)813-2719
Northrop Grumman Mission Systems	15055	Linthicum, MD	Foundry Services; Packaging/Assembly; Test	Jeff Miller	j3.miller@ngc.com	(410) 765-3958
Novati Technologies, Inc.	6T0L1	Austin, Texas	Broker; Foundry Services; Post Processing; Packaging/Assembly	Tim Scott	tim.scott@novati-tech.com	(512) 356-2007
NSA Microelectronics Solutions Group	98230	Fort Meade, MD	Design; Packaging/Assembly; Test			
ON Semiconductor - Gresham	5V1J0	Gresham, OR	Broker; Foundry Services; Post Processing	Terry Danzer Marketing Manager - DMI	terry.danzer@onsemi.com	(208) 234-6009
ON Semiconductor - Pocatello	31471	Pocatello, ID	Broker; Design; Foundry Services; Test	Terry Danzer Marketing Manager - DMI	terry.danzer@onsemi.com	(208) 234-6009
Pantronix Corporation	2V289	Fremont, CA	Post Processing; Packaging/Assembly	Marketing Director	ptx@pantronix.com	(510) 656-5898
Photronics Texas Allen, Inc.	53Z12	Allen, TX	Mask Data Parsing; Mask Manufacturing	Wayne A. DeCarlo, VP North American Sales	wdecarlo@photronics.com	(203) 740-5356
Plexus Aerospace, Defense and Security Services, LLC	76QV7	Nampa, ID	Packaging/Assembly	Daniel Marsh Director, Market Development	daniel.marsh@plexus.com	(480) 532-2467
Qorvo Texas, LLC	1CVM1	Richardson, TX	Design; Foundry Services; Post Processing; Packaging/Assembly; Test	Douglas Cole	TrustedIC@qorvo.com	(972) 994-3965
Raytheon Missile Systems	15090	Tucson, AZ	Broker; Design	Bryon Hoinke	bryon_hoinke@raytheon.com	(520) 794-4226
Raytheon RF Components	05716	Andover, MA	Foundry Services	Ronald Gyurcsik, Ph.D. Director, Foundry Business Development	ronald.gyurcsik@raytheon.com	(978) 684-5428
Raytheon Vision Systems	11323	Goleta, CA	Design	Eric Beuville, PH.D.	Eric_Beuville@Raytheon.com	(805) 562-2021
Rockwell Collins, Inc.	13499	Cedar Rapids, IA	Design; Packaging/Assembly; Test	Gary Schardt	gary.schardt@rockwellcollins.com	319-295-1375

Sandia National Laboratories Microsystems Science, Technology, & Components	14213	Albuquerque, NM	Design; Foundry Services; Test	Nathan Nowlin, Manager, Advanced MicroElectronics & Radiation Effects	nnowlin@sandia.gov	(505) 845-0086
Silanna Semiconductor	Z0FS6	Sydney Olympic Park, New South Wales, Australia	Design; Foundry Services; Post Processing	Jeremy Greenwood	jeremyg@silanna.com	61 2 9763 4135
Silicon Turnkey Solutions, Inc.	1VPP6	Milpitas, CA	Packaging/Assembly; Test	Marti McCurdy	MMccurdy@sts-usa.com	(408) 904-0251
Smart System Technology & Commercialization Center	4MKQ5	Canandaigua, NY	Aggregation; Post Processing; Packaging/Assembly	Paul Tolley, Executive Director	paul.tolley@stcmems.com	(585) 919-3001
SRI International	0DKS7	Princeton, NJ	Foundry Services	David Weaver, PhD	David.weaver@sri.com	(609) 720-4845
SypherMedia International	458E4	Westminster, CA	Design	Vice President, Business Development	gjgagnon@smi.tv	(714) 895-8801 x102
Sypris Electronics	24384	Tampa, Fl	Design	Chuck White	ManufacturingServices@sypris.com	(256) 829-9291
Teledyne Microelectronic Technologies	16170	Lewisburg, TN	Packaging/Assembly; Test	Harry Kellzi, DIrector Business Development	hkellzi@teledyne.com	(310) 574-2097
TLMI Corporation	3G0L2	Austin, TX	Post Processing	Michael Fredin	mfredin@tlmicorp.com	(512) 833-7075
Triad Semiconductor, Inc.	32TP3	Winston Salem, NC	Design; Aggregation	V.P. Sales	info@triadsemi.com	(336)774-2150
TSI Semiconductors America, LLC	6SKN8	Roseville, CA	Foundry Services	Wilbur Catabay	wilbur.catabay@tsisemi.com	(408) 678.8691
USC - ISI Arlington	06SU2	Arlington, VA	Design	Matthew French	mfrench@isi.edu	(703) 812-3733
USC - ISI Marina del Rey	1B729	Marina del Rey, CA	Design	Dr. Jeff Draper	draper@isi.edu	(310) 448-8750
USC-ISI - MOSIS	1B729	Marina del Rey, CA	Broker; Aggregation	Wes Hansford, Deputy Director	hansford@mosis.com	(310) 448-9199
Vortex Aerospace Design & Labs, Inc.	35TC6	Melbourne, FL	Broker; Design; Aggregation	Curtis Turner	trustedDesign@vortexaerospace.com	(813) 435-0528

The Defense MicroElectronics Activity (DMEA) has been designated by the Department of Defense as the accrediting authority for this program. Send questions or comments to TrustedIC@dmea.osd.mil or call (916) 231-1514.

Trusted Integrated Circuit Supplier Fabrication Processes

| Trusted Foundry | CMOS | | | | | | | | | | | | NVRAM CMOS | | | | | | Mixed Signal CMOS | | | | | | | | Mixed Signal CMOS+ SONOS NVM | | | | | RF CMOS | | | | | HV CMOS | | | | | | RH CMOS | | | | | | | | CMOS Image Sensor | | SOI CMOS | | | | | | | | | Thin Film SOI CMOS | | RH SOI CMOS | | | | SOS | | | BiCMOS | | | | | | | | CCD Image Sensor | | | Bipolar | | GaAs | | | | | | | | | GaN | | | | | | InP | | | | SiGe SOI | SiGe | | | | | | |
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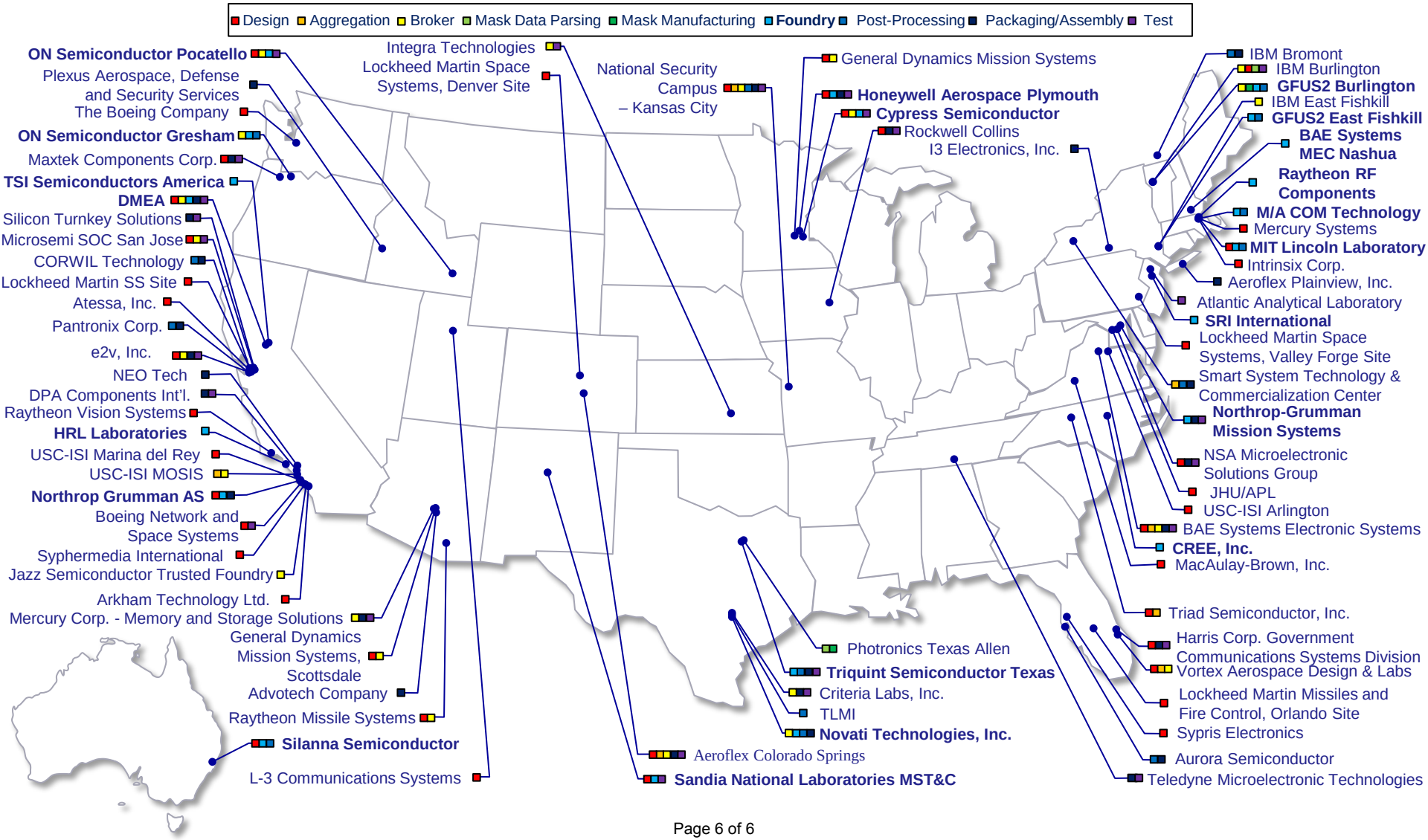
76 Trusted Suppliers



As of 28 November 2016